



T3V3LCS3

LOW CAPACITANCE SURFACE MOUNT TVS

Features

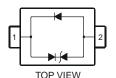
- 350 Watts Peak Pulse Power (tp = 8x20μs)
- IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- IEC 61000-4-4 (EFT): 40A 5/50ns
- IEC 61000-4-5 (Surge): 24A, 8/20μs Level 2(Line-Gnd) & Level 3(Line-Line)
- Low Capacitance, typ. = 3 pF
- Unidirectional Configuration
- Lead Free/RoHS Compliant (Note 4)
- "Green" Device (Note 5)

Mechanical Data

- Case: SOD-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: Cathode Band, See Page 2
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.004 grams (approximate)







Device Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Pulse Power (tp = 8x20μs) (Note 7) T _A = 25°C	P_{pk}	350	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Ambient (Note 7) T _A = 25°C	$R_{ hetaJA}$	425	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

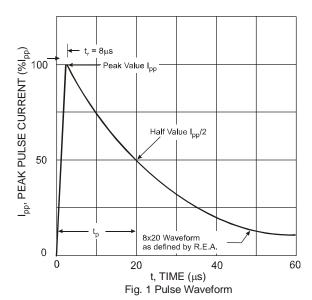
Electrical Characteristics @T_A = 25°C unless otherwise specified (Note 8)

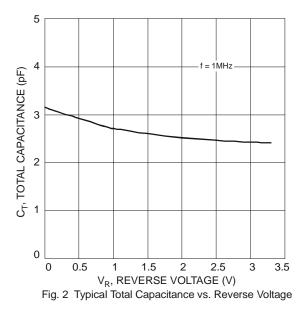
Reverse Standoff Voltage		n Voltage @ I _T	Test Current	Max. Reverse Leakage @ V _{RWM} (Note 6)	Max. Clamping Voltage @ I _{pp} = 1A (Note 3)		amping V _C @ I _{PP} te 3)	Typical Total Capacitance C _T (Note 1)
V _{RWM} (V)	Min (V)	Max (V)	I _T (mA)	I _R (μA)	V _C (V)	V _C (V)	I _{PP} (A)	(pF)
3.3	4.0		1.0	5	7	19	20	3

Notes:

- 1. $V_R = 0V$, f = 1MHz.
- 2. $tp = 8x20\mu s$.
- 3. Clamping voltage value is based on an 8x20 µs peak pulse current (Ipp) waveform (see figure 1).
- No purposefully added lead.
- 5. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 6. Short duration pulse test used to minimize self-heating effect.
- Device mounted on FR-4 PC board with suggested pad layout, which can be found on page 3 or on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- Positive potential is applied from pin 2 to pin 1.







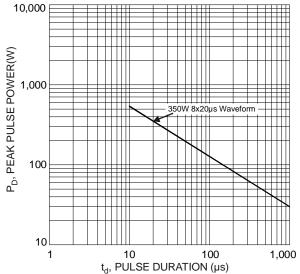


Fig. 3 Max. Peak Pulse Power vs. Power Duration

Ordering Information (Note 9)

Part Number	Case	Packaging
T3V3LCS3-7	SOD-323	3000/Tape & Reel

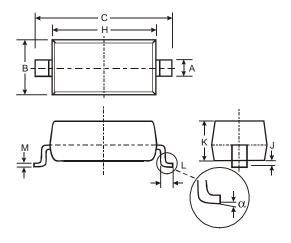
Notes: 9. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



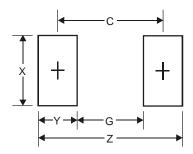


Package Outline Dimensions



SOD-323			
Dim	Min	Max	
Α	0.25	0.35	
В	1.20	1.40	
С	2.30	2.70	
Н	1.60	1.80	
J	0.00	0.10	
K	1.0	1.1	
L	0.20	0.40	
M	0.10	0.15	
α	0°	8°	
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.75
G	1.05
Х	0.65
Y	1.35
С	2.40

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